



March 27, 2019, Timișoara, Hotel Timișoara, Room ROMA 1

INNOVATION AND EFFICIENCY USING NUMERICAL SIMULATION IN ELECTRONICS

**AGENDA (draft)
Wednesday 27th of March, 2019**

09:00–10:00	<i>Attendees registration & welcome coffee</i>
10:00–10:10	<i>WELCOME speech</i> Cristina OPREA, TENSOR
10:10-10:30	<i>ANSYS Inc corporate overview</i> Martin MANN, ANSYS Germany / Shiv KUTTY, ANSYS US
10:30-11:00	<i>ANSYS HFSS update</i> Nicolae BĂDULESCU, TENSOR / ANSYS AE HF specialist
11:00–11:30	<i>ANSYS MAXWELL update</i> Nicolae BĂDULESCU, TENSOR
11:30-11:50	<i>Coffee Break</i>
11:50-12:20	<i>OPTIS intro</i> Răzvan MAHU, TENSOR / OPTIS rep.
12:20-12:50	<i>ANSYS Twin Builder & Icepak update</i> Nicolae BĂDULESCU, TENSOR
12:50-13:20	<i>ANSYS user presentation</i> xxx xxx, Institute/company
13:20-14:30	<i>Lunch and networking break</i>
14:30-15:00	<i>ANSYS SIwave update</i> Nicolae BĂDULESCU, TENSOR / ANSYS AE HF specialist
15:00-15:30	<i>ANSYS user presentation</i> xxx xxx, Institute/company
15:30-16:00	<i>ANSYS user presentation</i> xxx xxx, Institute/company
16:00-16:30	<i>Coffee break</i>
16:30-17:00	<i>ANSYS user presentation/ Workshop</i> xxx xxx, Institute/company
17:00-17:30	<i>ANSYS user presentation/ Workshop</i> xxx xxx, Institute/company
17:30-18:00	<i>ANSYS user presentation/ Workshop</i> xxx xxx, Institute/company
18:00-18:30	Q&A & prizes awarding
18:30-23:00	Dinner (Hotel Timișoara)